

Figure 1: Internal schematic diagram

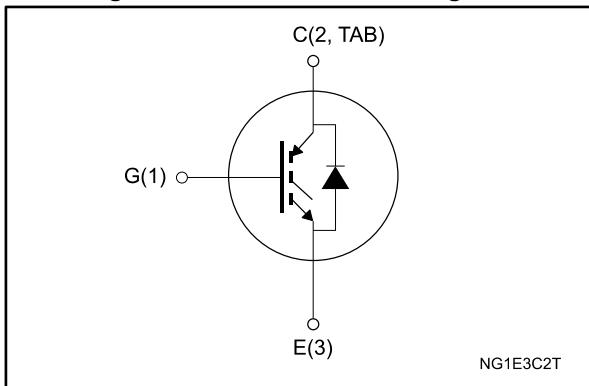


Table 1: Device summary

Order code	Marking	Package	Packing
STGB14NC60KDT4	GB14NC60KD	D ² PAK	Tape and reel
STGF14NC60KD	GF14NC60KD	TO-220FP	
STGP14NC60KD	GP14NC60KD	TO-220	Tube

Features

- Low on voltage drop ($V_{CE(sat)}$)
- Low C_{res} / C_{ies} ratio (no cross-conduction susceptibility)
- Very soft ultrafast recovery antiparallel diode
- Short-circuit withstand time 10 μ s

Applications

- High frequency inverters
- SMPS and PFC in both hard switch and resonant topologies
- Motor drives

Description

These devices are very fast IGBTs developed using advanced PowerMESH™ technology. This process guarantees an excellent trade-off between switching performance and low on-state behavior.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value		Unit
		D ² PAK, TO-220	TO-220FP	
V _{CES}	Collector-emitter voltage ($V_{GE} = 0$ V)	600		V
I _C ⁽¹⁾	Continuous collector current at $T_c = 25$ °C	25	11	A
	Continuous collector current at $T_c = 100$ °C	14	7	A
I _{CL} ⁽²⁾	Turn-off latching current	50		A
I _{CP} ⁽³⁾	Pulsed collector current	50		A
V _{GE}	Gate-emitter voltage	±20		V
I _F	Diode RMS forward current at $T_c=25$ °C	20		A
I _{FSM}	Surge non repetitive forward current $t_p = 10$ ms sinusoidal	55		A
P _{TOT}	Total dissipation at $T_c = 25$ °C	80	28	W
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink ($t=1$ s; $T_c=25$ °C)		2500	V
t _{scw}	Short-circuit withstand time $V_{CE} = 300$ V, $T_j = 125$ °C, $R_G = 10 \Omega$, $V_{GE} = 12$ V	10		μs
T _{stg}	Storage temperature range	- 55 to 150	°C	°C
T _J	Operating junction temperature range			

Notes:

(1)Calculated according to the iterative formula:

$$I_C(T_c) = \frac{T_{j(max)} - T_c}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_C(T_c))}$$

(2)V_{clamp} = 80 % V_{CES}, V_{GE} = 15 V, R_G = 10 Ω, T_J = 150 °C.

(3)Pulse width limited by maximum junction temperature and turn-off within RBSOA.

Table 3: Thermal data

Symbol	Parameter	Value		Unit
		D ² PAK, TO-220	TO-220FP	
R _{thj-case}	Thermal resistance junction-case IGBT	1.56	4.5	°C/W
R _{thj-case}	Thermal resistance junction-case diode	2.2	5.6	
R _{thj-amb}	Thermal resistance junction-ambient	62.5		

2 Electrical characteristics

$T_C = 25^\circ\text{C}$ unless otherwise specified

Table 4: Static characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage	$I_C = 1 \text{ mA}, V_{GE} = 0 \text{ V}$	600			V
$V_{CE(\text{sat})}$	Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, I_C = 7 \text{ A}$		2.1	2.5	V
		$V_{GE} = 15 \text{ V}, I_C = 7 \text{ A}, T_j = 125^\circ\text{C}$		1.8		
$V_{GE(\text{th})}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 250 \mu\text{A}$	4.5		6.5	V
I_{CES}	Collector cut-off current	$V_{CE} = 600 \text{ V}, V_{GE} = 0 \text{ V}$			150	μA
		$V_{CE} = 600 \text{ V}, V_{GE} = 0 \text{ V}, T_j = 125^\circ\text{C}$ (1)			1	mA
I_{GES}	Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = \pm 20 \text{ V}$			± 100	nA
g_{fs} (2)	Forward transconductance	$V_{CE} = 15 \text{ V}, I_C = 7 \text{ A}$		3.2		S

Notes:

(1)Defined by design, not subject to production test.

(2)Pulsed: Pulse duration = 300 μs , duty cycle 1.5%.

Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies}	Input capacitance	$V_{CE} = 25 \text{ V}, f = 1 \text{ MHz}, V_{GE} = 0 \text{ V}$	-	760	-	pF
C_{oes}	Output capacitance		-	86	-	
C_{res}	Reverse transfer capacitance		-	15.5	-	
Q_g	Total gate charge	$V_{CE} = 390 \text{ V}, I_C = 7 \text{ A}, V_{GE} = 0 \text{ to } 15 \text{ V}$ (see Figure 19: "Gate charge test circuit")	-	34.4	-	nC
Q_{ge}	Gate-emitter charge		-	8.1	-	
Q_{gc}	Gate-collector charge		-	16.4	-	

Table 6: Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{CC} = 390 \text{ V}, I_C = 7 \text{ A}, R_G = 10 \Omega, V_{GE} = 15 \text{ V}$ (see Figure 18: "Test circuit for inductive load switching" and Figure 20: "Switching waveform")	-	22.5	-	ns
t_r	Current rise time		-	8.5	-	ns
$(di/dt)_{on}$	Turn-on current slope		-	700	-	A/ μs
$t_{d(on)}$	Turn-on delay time	$V_{CC} = 390 \text{ V}, I_C = 7 \text{ A}, R_G = 10 \Omega, V_{GE} = 15 \text{ V}, T_j = 125^\circ\text{C}$ (see Figure 18: "Test circuit for inductive load switching" and Figure 20: "Switching waveform")	-	22	-	ns
t_r	Current rise time		-	9.5	-	ns
$(di/dt)_{on}$	Turn-on current slope		-	680	-	A/ μs
$t_{r(V_{off})}$	Off voltage rise time	$V_{CC} = 390 \text{ V}, I_C = 7 \text{ A}, R_G = 10 \Omega, V_{GE} = 15 \text{ V}$ (see Figure 18: "Test circuit for inductive load switching" and Figure 20: "Switching waveform")	-	60	-	ns
$t_{d(off)}$	Turn-off delay time		-	116	-	ns
t_f	Current fall time		-	75	-	ns
$t_{r(V_{off})}$	Off voltage rise time	$V_{CC} = 390 \text{ V}, I_C = 7 \text{ A}, R_G = 10 \Omega, V_{GE} = 15 \text{ V}, T_j = 125^\circ\text{C}$ (see Figure 18: "Test circuit for inductive load switching" and Figure 20: "Switching waveform")	-	24	-	ns
$t_{d(off)}$	Turn-off delay time		-	196	-	ns
t_f	Current fall time		-	144	-	ns

Table 7: Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$E_{on}^{(1)}$	Turn-on switching energy	$V_{CC} = 390 \text{ V}, I_C = 7 \text{ A}, R_G = 10 \Omega, V_{GE} = 15 \text{ V}$ (see Figure 18: "Test circuit for inductive load switching")	-	82	-	μJ
$E_{off}^{(2)}$	Turn-off switching energy		-	155	-	μJ
E_{ts}	Total switching energy		-	237	-	μJ
$E_{on}^{(1)}$	Turn-on switching energy	$V_{CC} = 390 \text{ V}, I_C = 7 \text{ A}, R_G = 10 \Omega, V_{GE} = 15 \text{ V}, T_j = 125^\circ\text{C}$ (see Figure 18: "Test circuit for inductive load switching")	-	131	-	μJ
$E_{off}^{(2)}$	Turn-off switching energy		-	370	-	μJ
E_{ts}	Total switching energy		-	501	-	μJ

Notes:

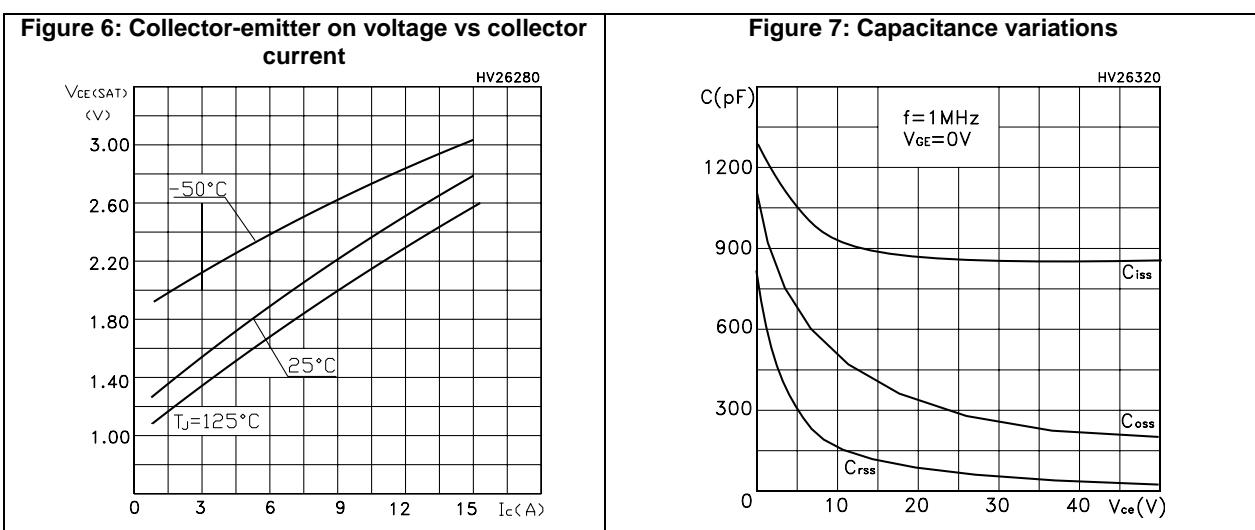
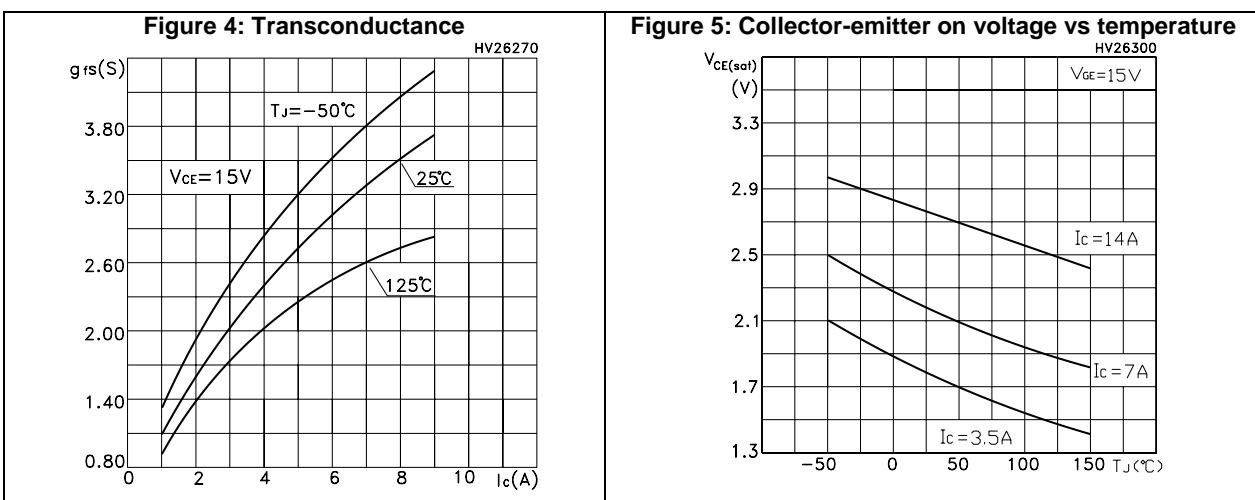
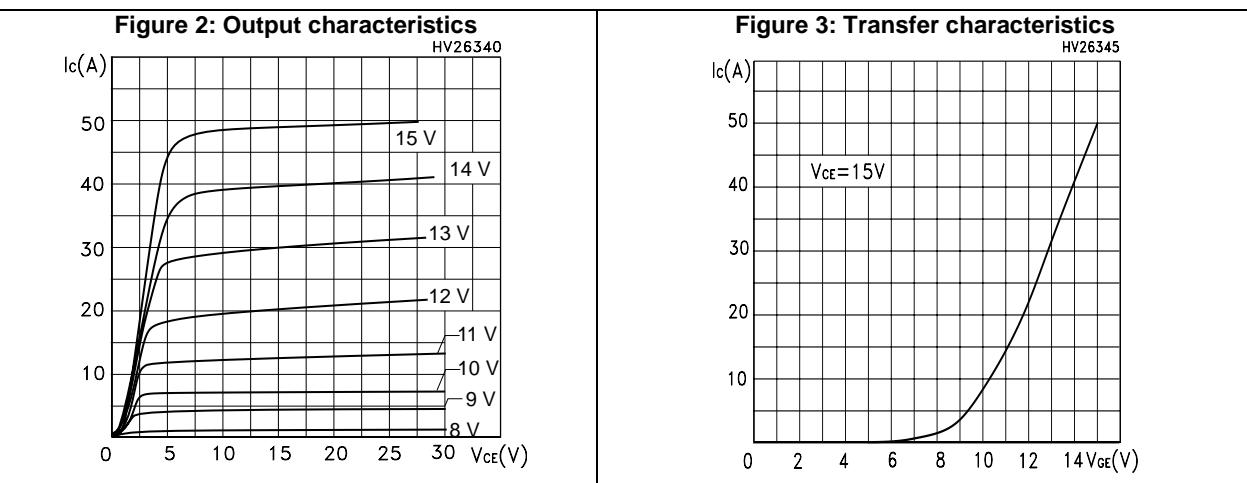
⁽¹⁾Including the reverse recovery of the diode.

⁽²⁾Including the tail of the collector current.

Table 8: Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_F	Forward on-voltage	$I_F=7 \text{ A}$	-	1.8	2.1	V
		$I_F=7 \text{ A}, T_j=125 \text{ }^\circ\text{C}$	-	1.3		V
t_{rr}	Reverse recovery time		-	37		ns
Q_{rr}	Reverse recovery charge	$I_F=7 \text{ A}, V_R=40 \text{ V}, di/dt=100 \text{ A}/\mu\text{s}$ (see <i>Figure 21: "Diode reverse recovery waveform"</i>)	-	40		nC
			-	2.1		A
			-	61		ns
Q_{rr}	Reverse recovery charge	$I_F=7 \text{ A}, V_R=40 \text{ V}, T_j=125 \text{ }^\circ\text{C},$ $di/dt=100 \text{ A}/\mu\text{s}$ (see <i>Figure 21: "Diode reverse recovery waveform"</i>)	-	98		nC
			-	3.2		A
I_{rrm}	Reverse recovery current					

2.1 Electrical characteristics (curves)



Electrical characteristics

**STGB14NC60KDT4, STGF14NC60KD,
STGP14NC60KD**

Figure 8: Normalized gate threshold voltage vs temperature

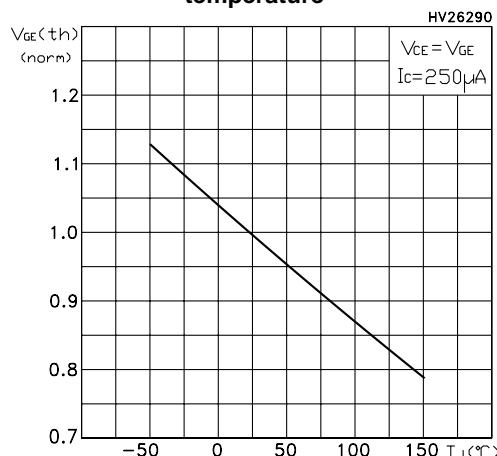


Figure 9: Gate charge vs gate-emitter voltage

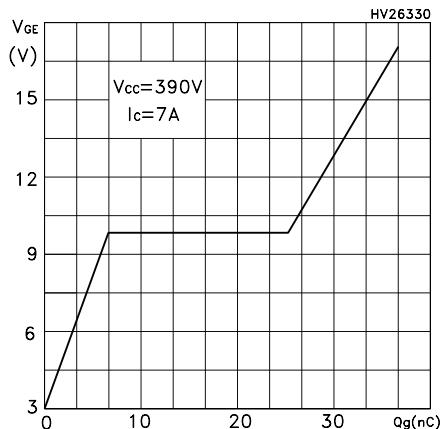


Figure 10: Normalized breakdown voltage vs temperature

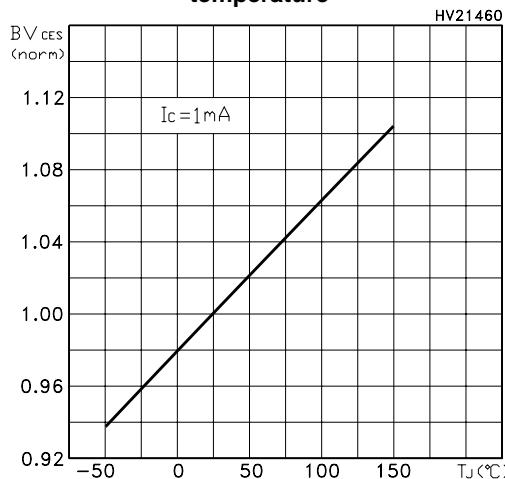


Figure 11: Switching energy vs temperature

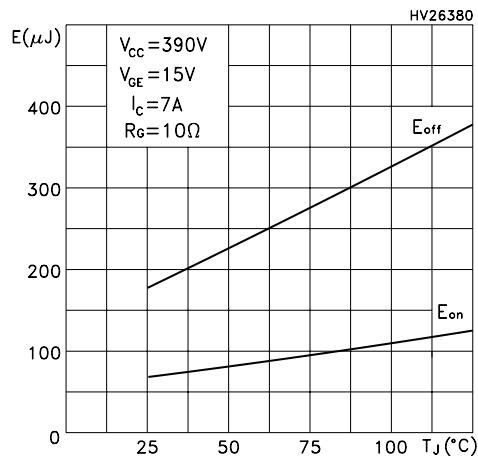


Figure 12: Switching energy vs gate resistance

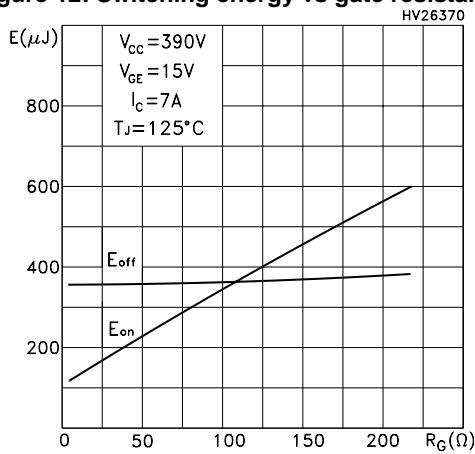


Figure 13: Switching energy vs collector current

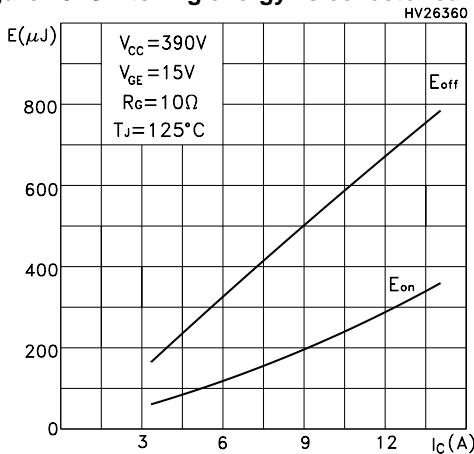


Figure 14: Thermal impedance for D²PAK and TO-220

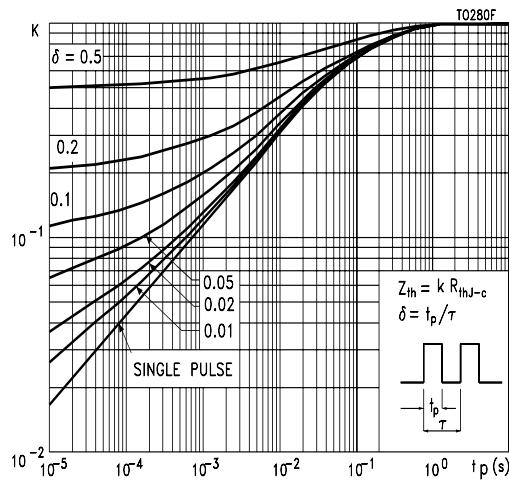


Figure 15: Turn-off SOA

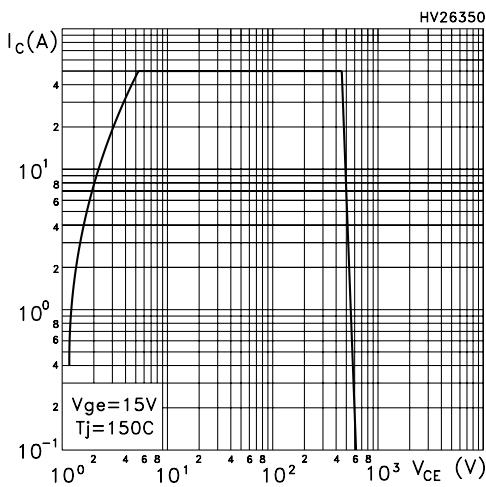


Figure 16: Thermal impedance for TO-220FP

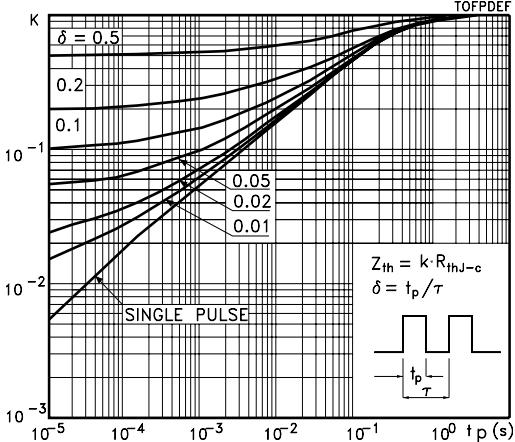
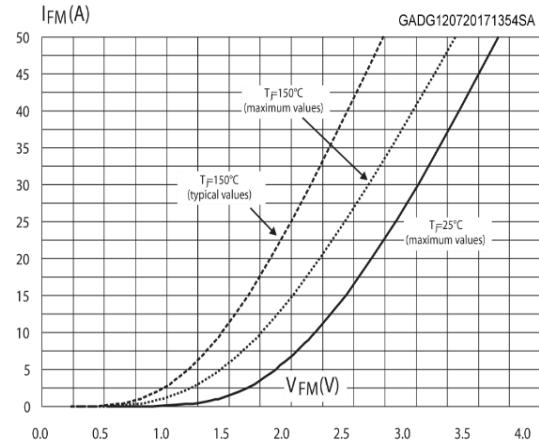
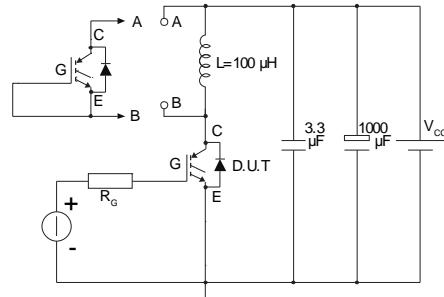


Figure 17: Forward voltage drop vs forward current



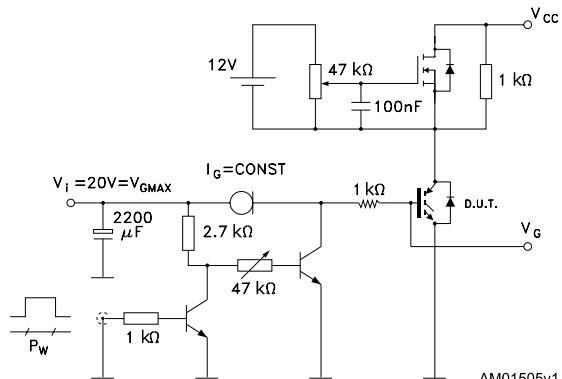
3 Test circuits

Figure 18: Test circuit for inductive load switching



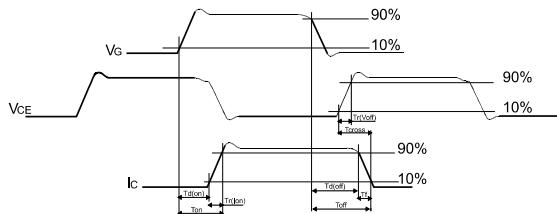
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Figure 19: Gate charge test circuit



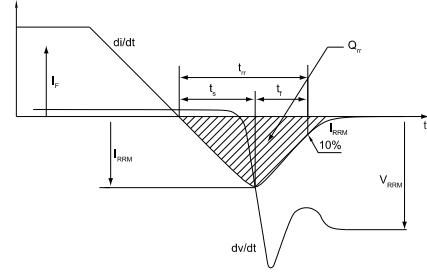
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Figure 20: Switching waveform



AM01506v1

Figure 21: Diode reverse recovery waveform



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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
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4.1 D²PAK (TO-263) type A package information

Figure 22: D²PAK (TO-263) type A package outline

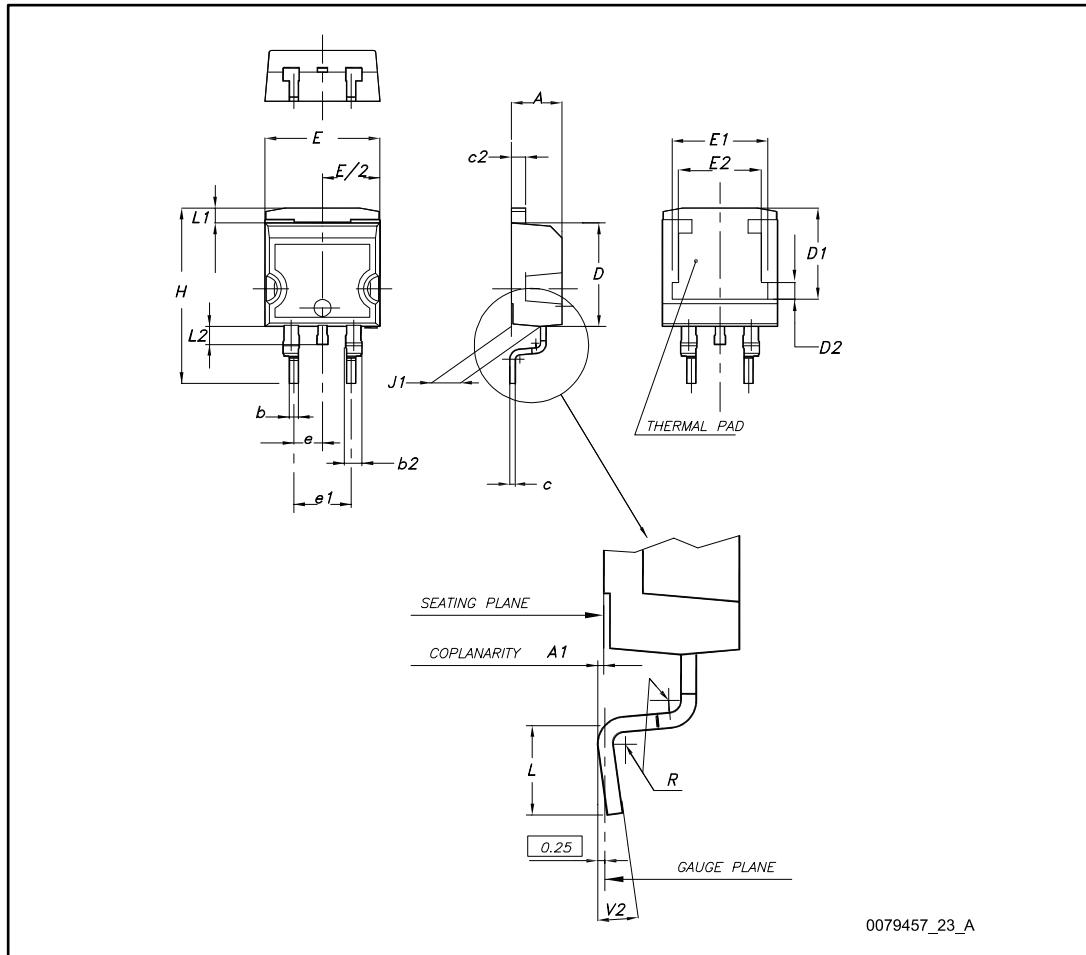
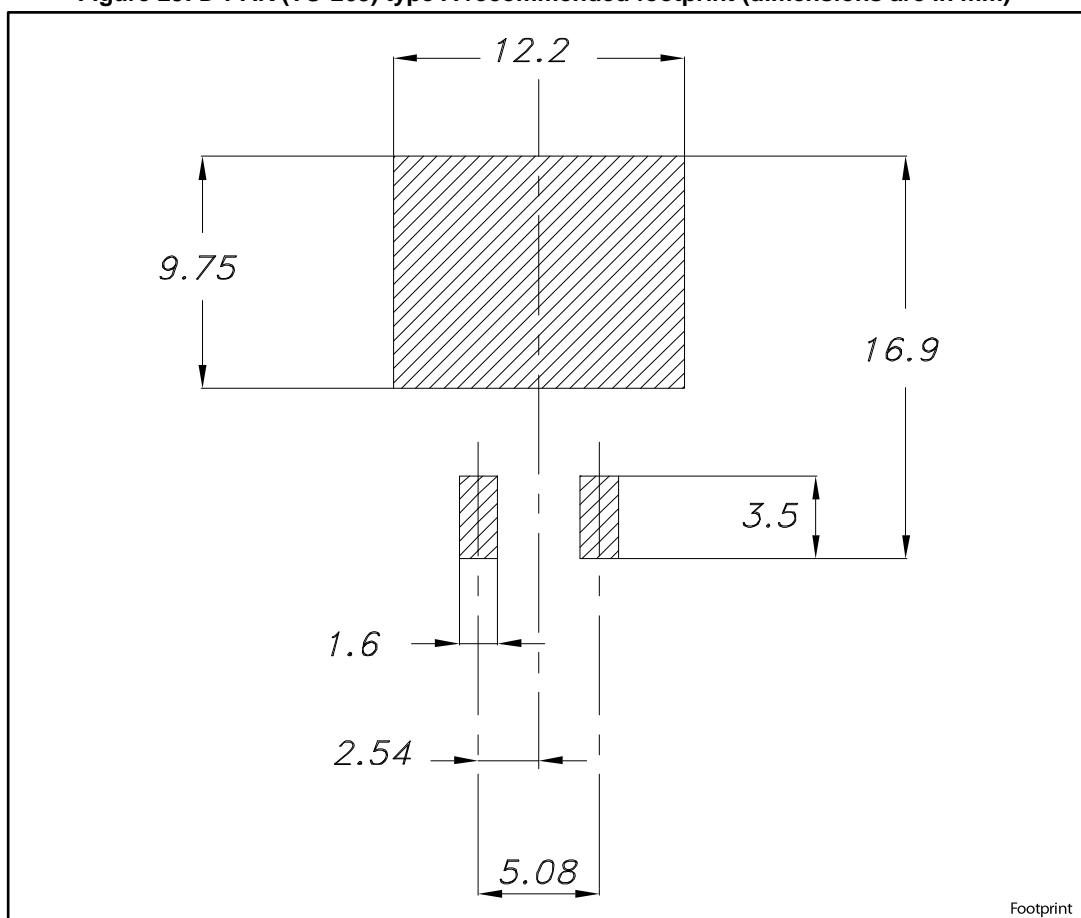


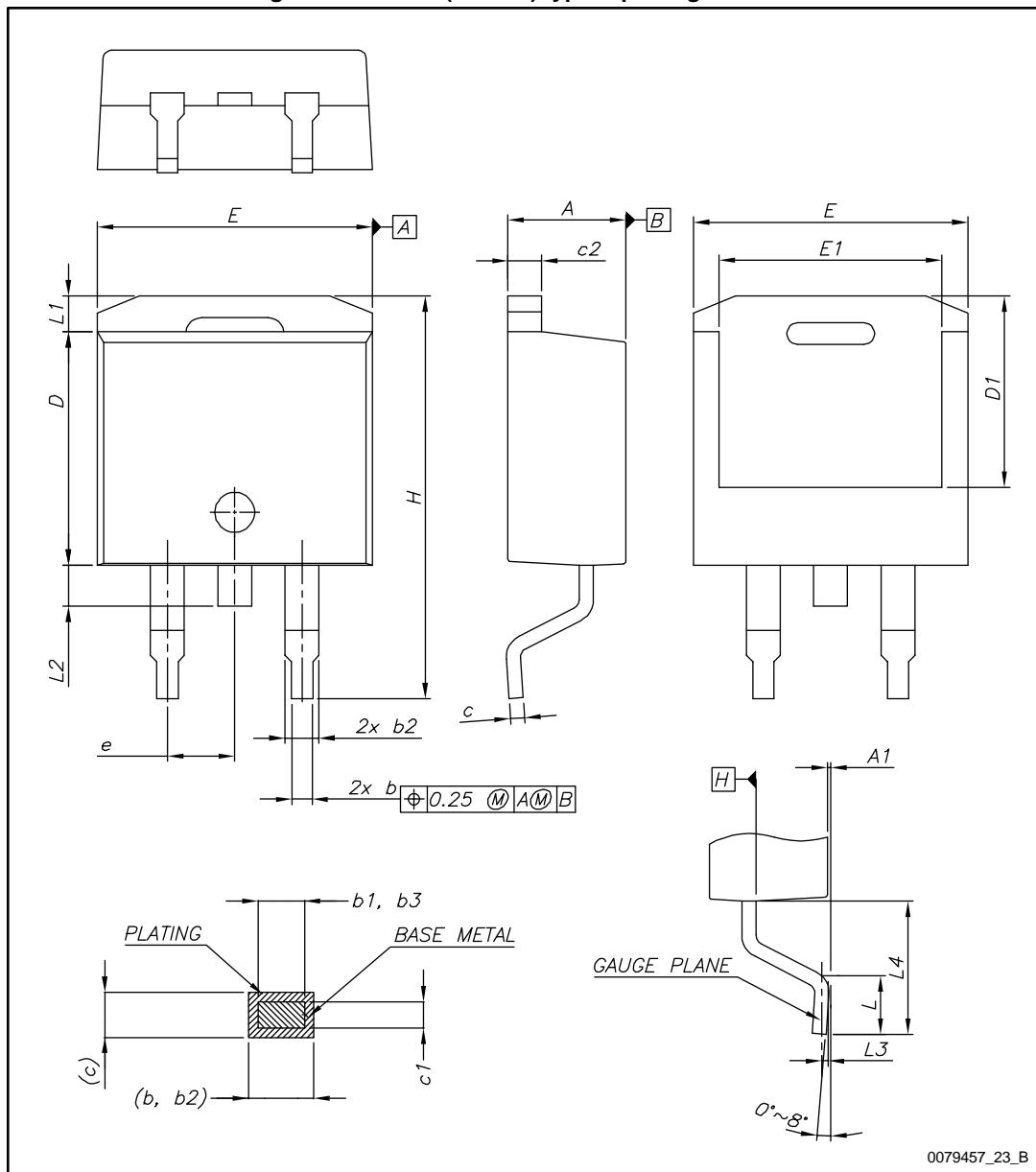
Table 9: D²PAK (TO-263) type A package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
c	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50	7.75	8.00
D2	1.10	1.30	1.50
E	10.00		10.40
E1	8.50	8.70	8.90
E2	6.85	7.05	7.25
e		2.54	
e1	4.88		5.28
H	15.00		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.40	
V2	0°		8°

Figure 23: D²PAK (TO-263) type A recommended footprint (dimensions are in mm)



4.2 D²PAK (TO-263) type B package information

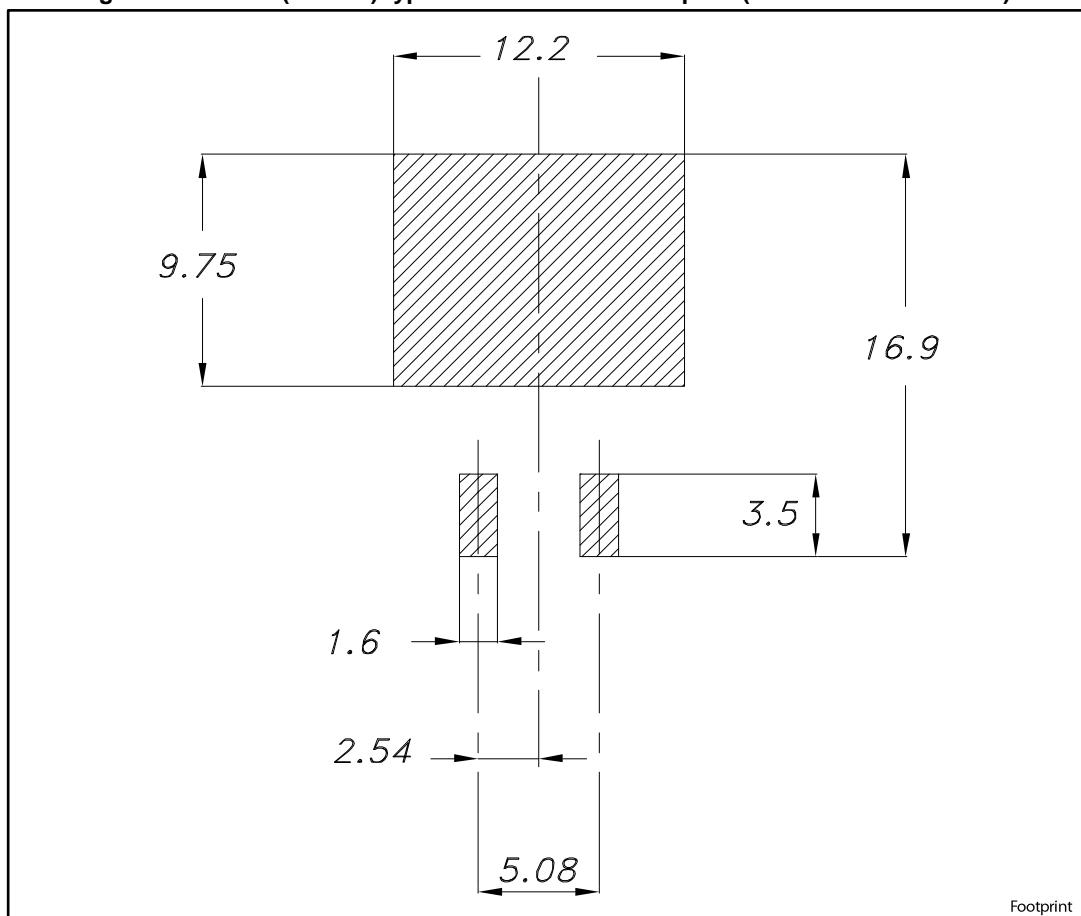
Figure 24: D²PAK (TO-263) type B package outline

0079457_23_B

Table 10: D²PAK (TO-263) type B mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.36		4.56
A1	0		0.25
b	0.70		0.90
b1	0.51		0.89
b2	1.17		1.37
b3	1.36		1.46
c	0.38		0.694
c1	0.38		0.534
c2	1.19		1.34
D	8.60		9.00
D1	6.90		7.50
E	10.15		10.55
E1	8.10		8.70
e	2.54 BSC		
H	15.00		15.60
L	1.90		2.50
L1			1.65
L2			1.78
L3		0.25	
L4	4.78		5.28

Figure 25: D²PAK (TO-263) type B recommended footprint (dimensions are in mm)



4.3 D²PAK (TO-263) type A packing information

Figure 26: D²PAK type A tape outline

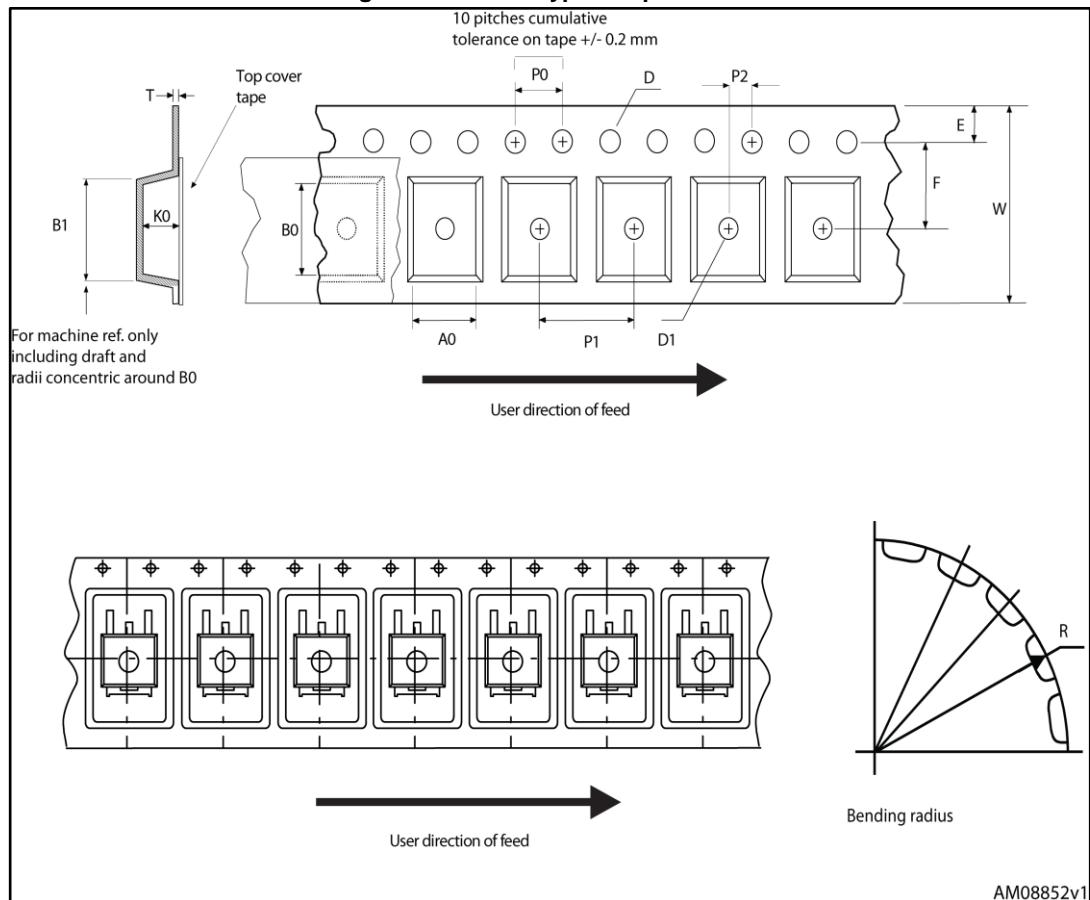
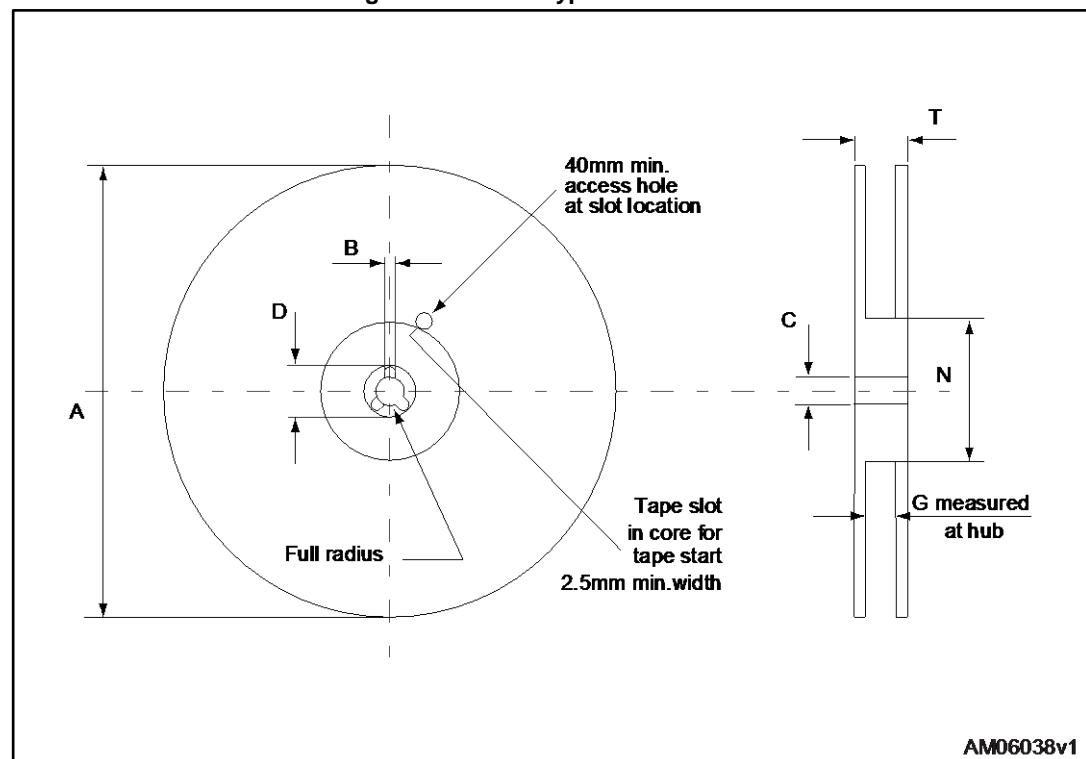


Figure 27: D²PAK type A reel outlineTable 11: D²PAK type A tape and reel mechanical data

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	10.5	10.7	A		330
B0	15.7	15.9	B	1.5	
D	1.5	1.6	C	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	T		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base quantity		1000
P2	1.9	2.1	Bulk quantity		1000
R	50				
T	0.25	0.35			
W	23.7	24.3			

4.4 D²PAK (TO-263) type B packing information

Figure 28: D²PAK type B tape outline

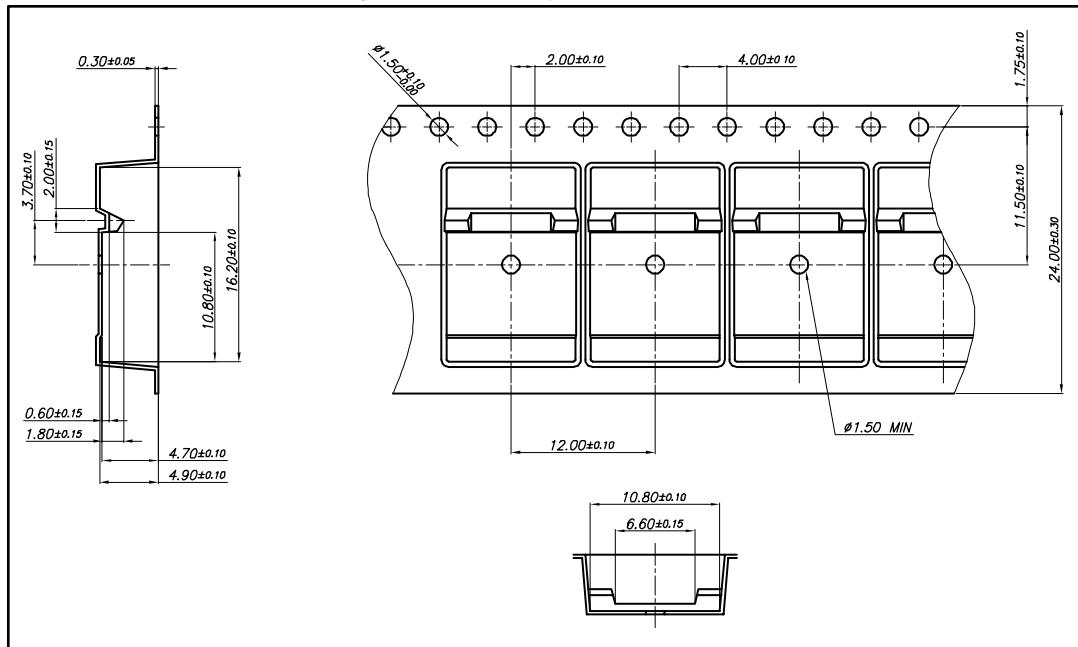


Figure 29: D²PAK type B reel outline

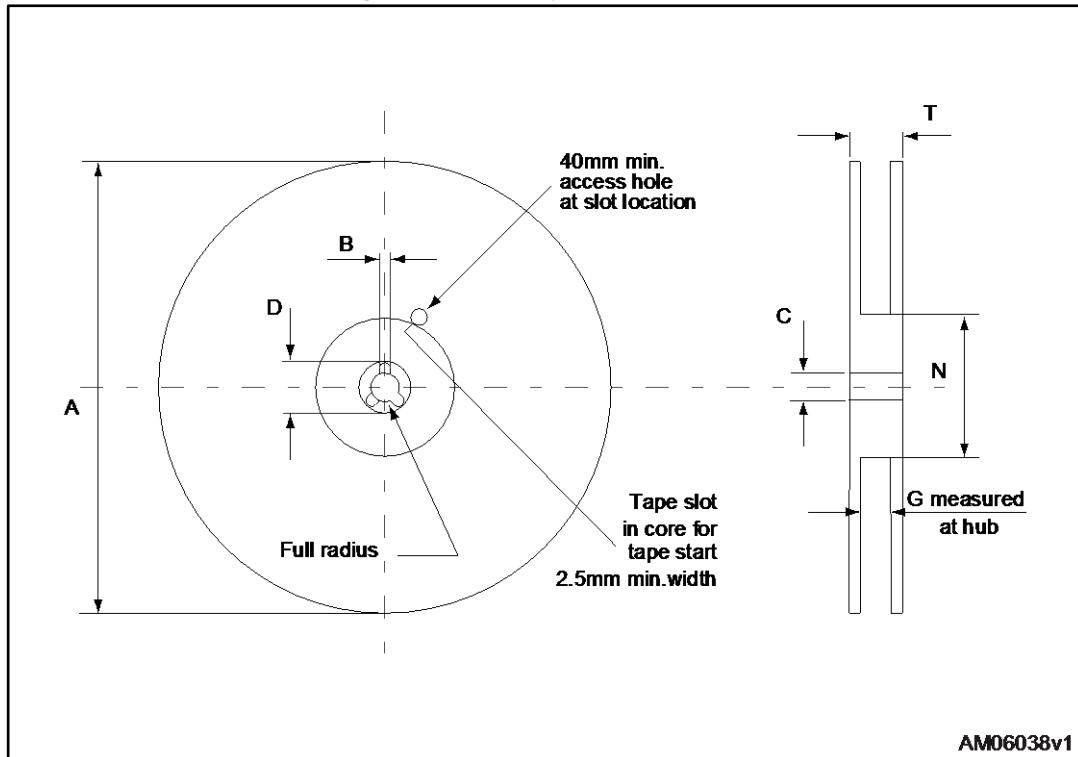
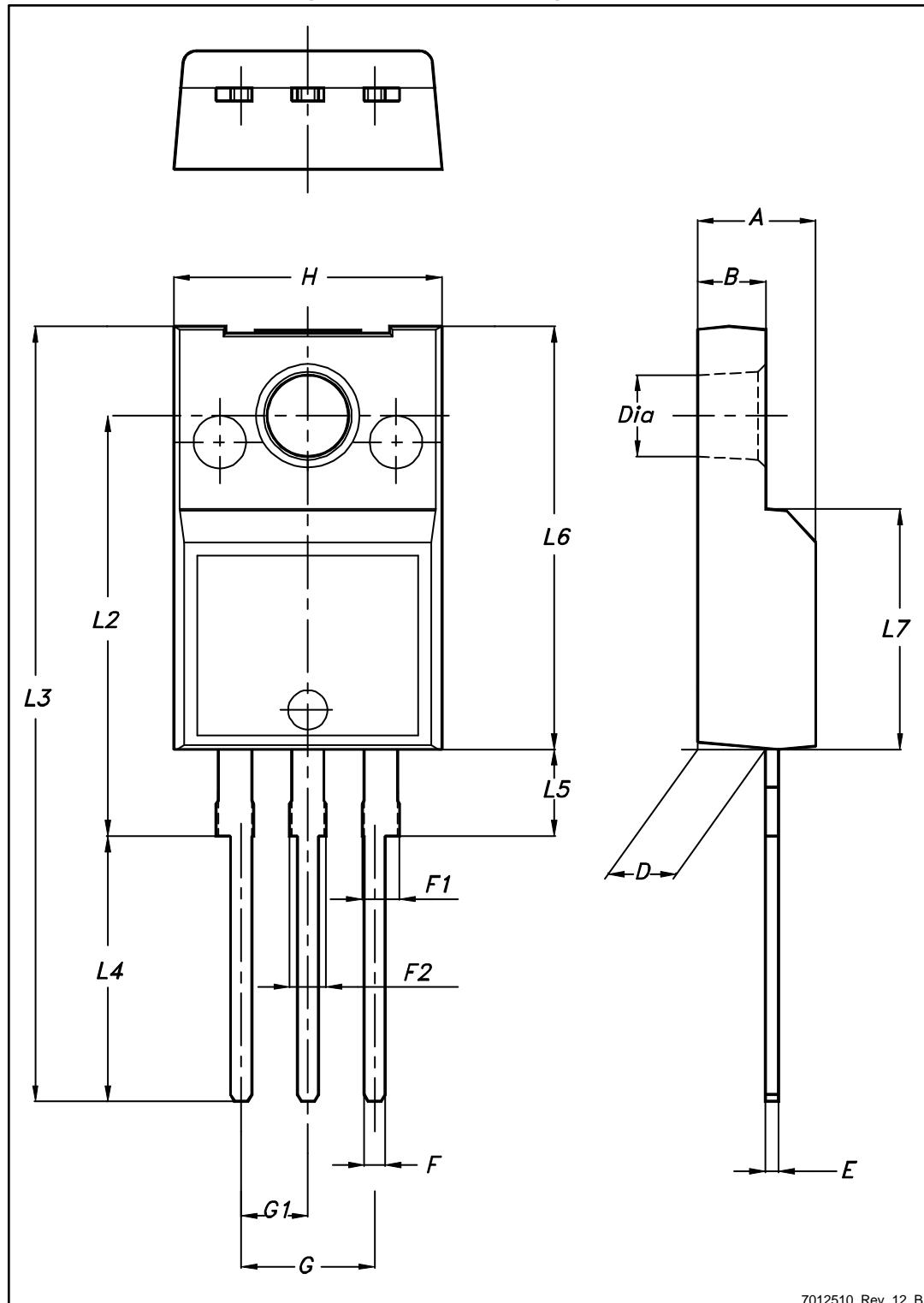


Table 12: D²PAK type B reel mechanical data

Dim.	mm	
	Min.	Max.
A		330
B	1.5	
C	12.8	13.2
D	20.2	
G	24.4	26.4
N	100	
T		30.4

4.5 TO-220FP package information

Figure 30: TO-220FP package outline



7012510_Rev_12_B

Table 13: TO-220FP package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.4		4.6
B	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
H	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

4.6 TO-220 type A package information

Figure 31: TO-220 type A package outline

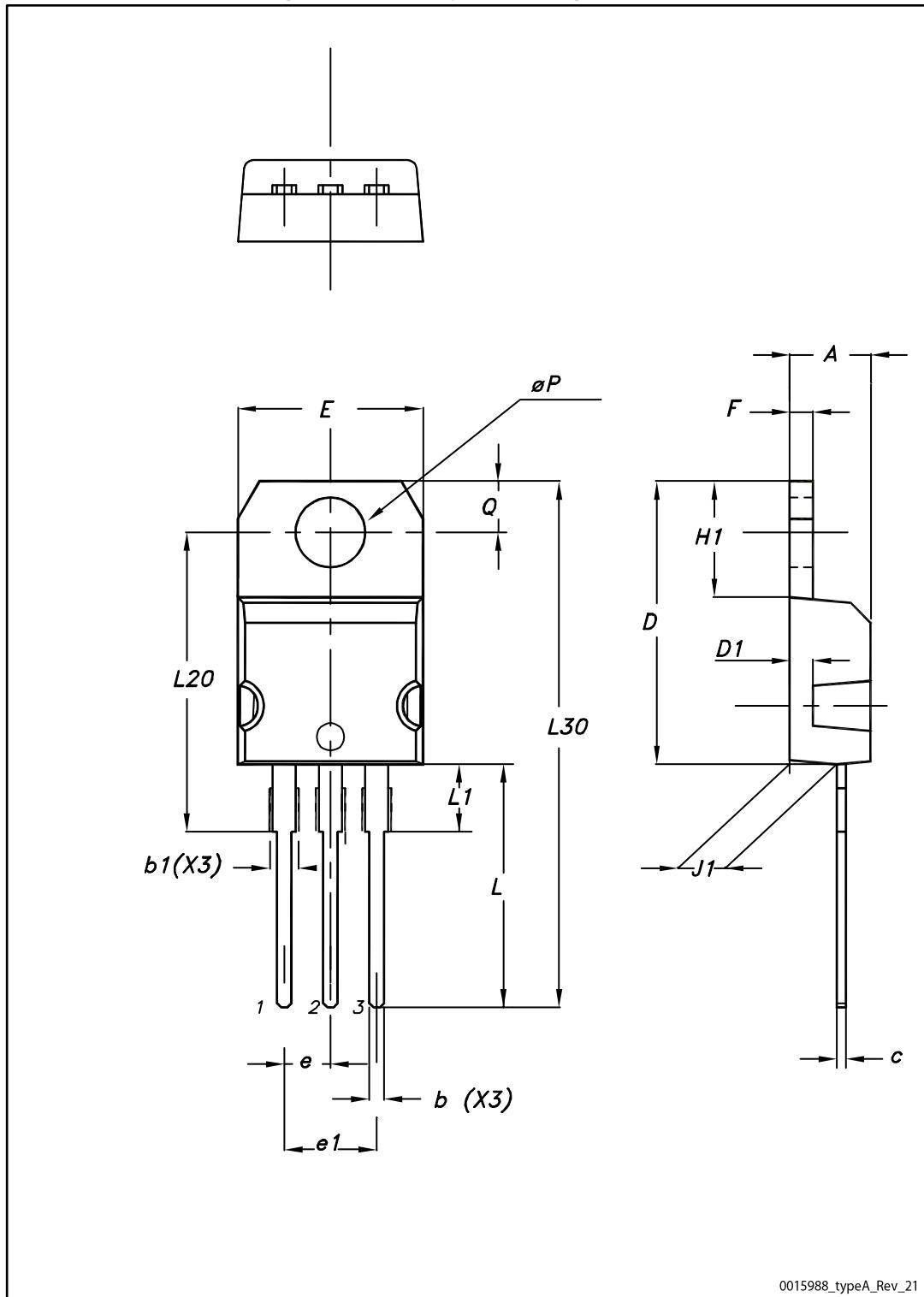


Table 14: TO-220 type A package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95

5 Revision history

Table 15: Document revision history

Date	Revision	Changes
14-Jun-2005	1	New release
05-Jul-2005	2	Complete version
22-Jul-2005	3	Value changed in table 6
27-Jan-2006	4	Inserted ecopack indication
28-Apr-2006	5	New template, modified curves 6 and 8
02-Apr-2008	6	Modified test conditions on Table 4
15-Mar-2010	7	Updated packages mechanical data.
12-Jul-2017	8	Modified <i>Table 6: "Switching on/off (inductive load)"</i> , <i>Table 7: "Switching energy (inductive load)"</i> and <i>Table 8: "Collector-emitter diode"</i> . Updated <i>Section 4: "Package information"</i> . Minor text changes.

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[748152A](#) [APT20GT60BRDQ1G](#) [APT50GT60BRG](#) [NGTB10N60FG](#) [STGFW20V60DF](#) [APT30GP60BG](#) [APT45GR65B2DU30](#)
[GT50JR22\(STA1ES\)](#) [TIG058E8-TL-H](#) [VS-CPV364M4KPBF](#) [NGTB25N120FL2WAG](#) [NGTG40N120FL2WG](#) [RJH60F3DPQ-A0#T0](#)
[APT40GR120B2SCD10](#) [APT15GT120BRG](#) [APT20GT60BRG](#) [NGTB75N65FL2WAG](#) [NGTG15N120FL2WG](#) [IXA30RG1200DHGLB](#)
[IXA40RG1200DHGLB](#) [APT70GR65B2DU40](#) [NTE3320](#) [IHFW40N65R5SXKSA1](#) [APT70GR120J](#) [APT35GP120JDQ2](#)
[IKZA40N65RH5XKSA1](#) [IKFW75N65ES5XKSA1](#) [IKFW50N65ES5XKSA1](#) [IKFW50N65EH5XKSA1](#) [IKFW40N65ES5XKSA1](#)
[IKFW60N65ES5XKSA1](#) [IMBG120R090M1HXTMA1](#) [IMBG120R220M1HXTMA1](#) [XD15H120CX1](#) [XD25H120CX0](#) [XP15PJS120CL1B1](#)
[IGW30N60H3FKSA1](#) [STGWA8M120DF3](#) [IGW08T120FKSA1](#) [IGW75N60H3FKSA1](#) [HGTG40N60B3](#) [FGH60N60SMD_F085](#)
[FGH75T65UPD](#) [STGWA15H120F2](#) [IKA10N60TXKSA1](#) [IHW20N120R5XKSA1](#) [RJH60D2DPP-M0#T2](#) [IKP20N60TXKSA1](#)
[IHW20N65R5XKSA1](#) [IDW40E65D2FKSA1](#)